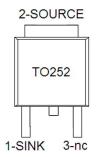
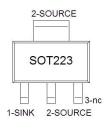
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Features

- · Limits regulated current
- 5mA, 10mA, 15mA, 20mA versions
- Rejects 50Hz / 60Hz ripple
- Low pin count
- 250V maximum operating voltage
- Zero external components
- Can be paralleled for higher current





Description

The CL1 product family are temperature compensated unipolar current regulators with versions available from 5mA to 20mA. It is designed to be used under a wide range of voltages, from 6V to 200V DC. The CL1 is primarily intended as a current limiting LED driver for serial LED applications in industrial lamp indicators, signage, accent and automotive lightning. Other applications include constant current source and sink.

The CL1 temperature coefficient is optimized from -40°C to 125°C. The CL1 will source or sink constant current. The CL1 will likely require a heat sink connected to the Source (pin 2).

Absolute Maximum Ratings¹

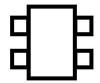
Maximum operating voltage ²	250V DC
Operating free air temperature range	40°C to 85°C
Storage Temperature	40°C to 85°C
ESD tolerance, human body model	500V

Note 1: Stresses beyond "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended period may impact device reliability.

Note 2: All voltages are with respect to Source.

Recommended Operating Conditions

	Min	Max	Unit
Operating Voltage	6	200	V DC
Operating free air temperature	-40	85	°C
Operating chip temperature	-40	135	°C



May 2021

Thermal Characteristics³

Ambient Temperature (25°C) unless otherwise specified

Parameter	Min	Тур	Max	Unit
SOT223 thermal resistance minimum copper layout		160		°C/Watt
SOT223 thermal resistance (0.60inch x 0.50inch)		88		°C/Watt
SOT223 thermal resistance (1.0inch x 1.0inch)		67		°C/Watt
TO252 thermal resistance minimum copper layout		110		°C/Watt
TO252 thermal resistance (0.60inch x 0.50inch)		75		°C/Watt
TO252 thermal resistance (1.0inch x 1.0inch)		50		°C/Watt

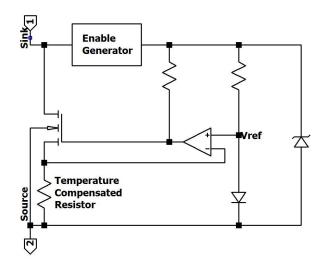
Note 3: Footprint copper layout size based on Package Heating Test Board (page 11)

Terminal Definition

Terminal Name	Pin No.	Туре	Description
Sink	1	HV Input	Sinks the load current
Source	2	VH Input	Usually Ground. Sources the load current.

May 2021

Functional Block Diagram

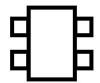


Concept of Operation

This chip is powered by applying a voltage difference between Sink and Source terminal. As the voltage rises, the N-Channel MOSFET begins to conduct current between Sink and Source terminals. The temperature compensated source resistor senses this current and provides this feedback voltage to the non-inverting input of the operational amplifier. The operational amplifier compares the feedback voltage with the reference voltage provided by a p-n junction. The operational amplifier drives the gate of the N-channel MOSFET such that the feedback voltage and the reference voltage remain equal.

p-n junctions exhibit a negative temperature coefficient of approximately -2mV/°C. The Source resistor is temperature compensated to match the temperature coefficient of the p-n junction. In this way, the regulated current flowing between Sink and Source will be (to a first order) independent of the chip junction temperature.

The power dissipated by the chip is given simply as I_{lim} * (V_{Sink} - V_{Source}). The chip will likely require a heat sink mechanically connected to the Source terminal (pin 2).



May 2021

Electrical Characteristics

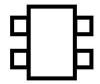
 V_{Sink} - $V_{Source} = 20V$, Temp = 25°C unless otherwise specified

20mA nominal device

Parameter	Min	Тур	Max	Unit
Regulated Current (I _{lim}) at 25 ^o C	18.5	21.2	24.0	mA
Regulated Current (I _{lim}) at -40°c		19.1		mA
Regulated Current (I _{lim}) at +85°C		21.6		mA
Absolute Temperate Coefficient		24		μA / °C
Minimum Operating Voltage (limits current to 90% of I _{lim})	3.5	4.7	6.0	V
Voltage Coefficient 10V to 200V (pulse 10mSec)		1.0	2.0	mA / 100V
Stabilization time to 10% of final value		2.0		μSec
Transient response 10% to 90%		300		nSec

15mA nominal device

Parameter	Min	Тур	Max	Unit
Regulated Current (I _{lim}) at 25°C	13.9	15.9	18.0	mA
Regulated Current (I _{lim}) at -40 ^o c		14.3		mA
Regulated Current (I _{lim}) at +85°C		16.2		mA
Absolute Temperate Coefficient		18		μ A / °C
Minimum Operating Voltage (limits current to 90% of I _{lim})	3.0	4.2	5.5	V
Voltage Coefficient 20V to 250V (pulse 10mSec)		0.75	1.5	mA / 100V
Stabilization time to 10% of final value		2.0		μSec
Transient response 10% to 90%		300		nSec



May 2021

Electrical Characteristics (cont.)

 V_{Sink} - $V_{Source} = 20V$, Temp = 25°C unless otherwise specified

10mA nominal device

Parameter	Min	Тур	Max	Unit
Regulated Current (I _{lim}) at 25°C	9.3	10.6	12	mA
Regulated Current (I _{lim}) at -40°c		9.5		mA
Regulated Current (I _{lim}) at +85°C		10.8		mA
Absolute Temperate Coefficient		12		μA / °C
Minimum Operating Voltage (limits current to 90% of I _{lim})	2.5	3.7	5.0	V
Voltage Coefficient 20V to 250V (pulse 10mSec)		0.5	1.0	mA / 100V
Stabilization time to 10% of final value		2.0		μSec
Transient response 10% to 90%		300		nSec

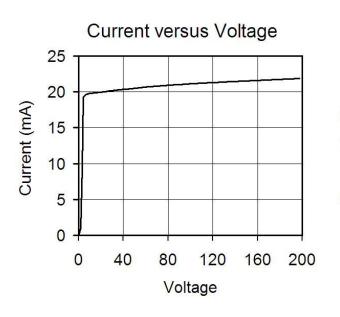
5mA nominal device

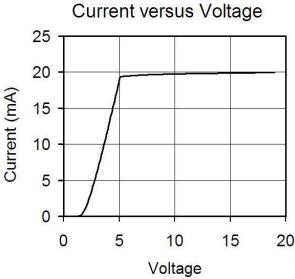
Parameter	Min	Тур	Max	Unit
Regulated Current (I _{lim}) at 25°C	4.6	5.3	6.0	mA
Regulated Current (I _{lim}) at -40°c		4.8		mA
Regulated Current (I _{lim}) at +85°C		5.4		mA
Absolute Temperate Coefficient		6		μ A / °C
Minimum Operating Voltage (limits current to 90% of I _{lim})	2.0	3.2	4.5	V
Voltage Coefficient 20V to 250V (pulse 10mSec)		0.25	0.5	mA / 100V
Stabilization time to 10% of final value		2.0		μSec
Transient response 10% to 90%		300		nSec

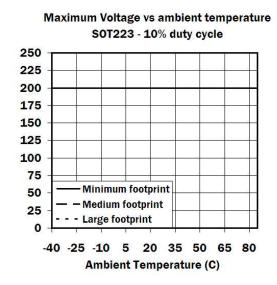
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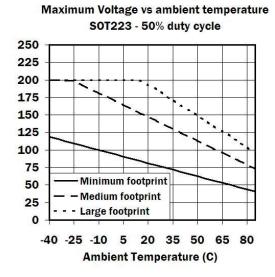
May 2021

Characteristic Curves (25°C, 20mA version)





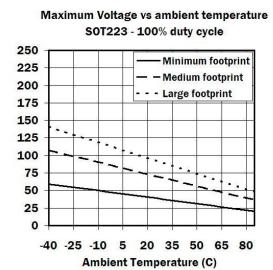


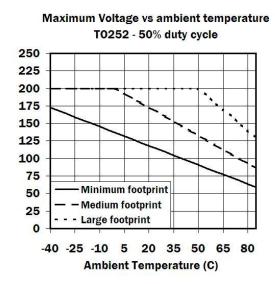


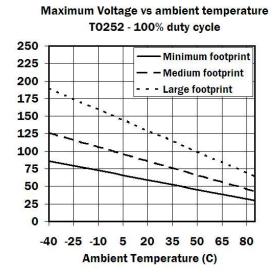
Note 4: Footprint size based on Package Heating Test Board (page 11)

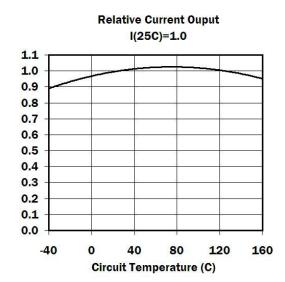
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Characteristic Curves (25°C, 20mA version)





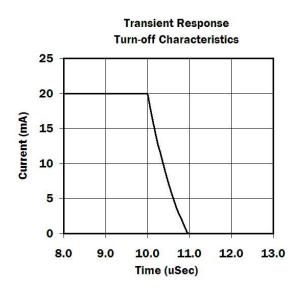


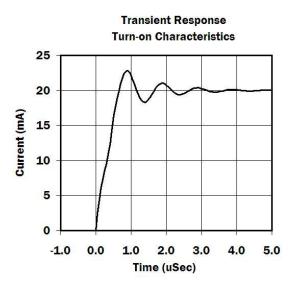


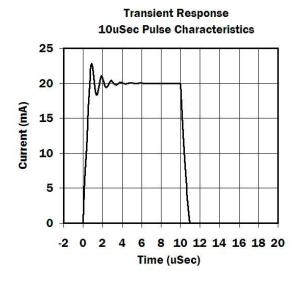
Note 5: Footprint size based on Package Heating Test Board (page 11)

May 2021

Characteristics curves (25°C, 20mA version)



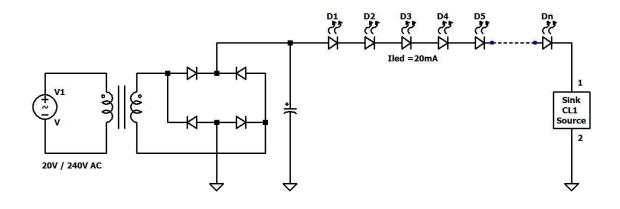


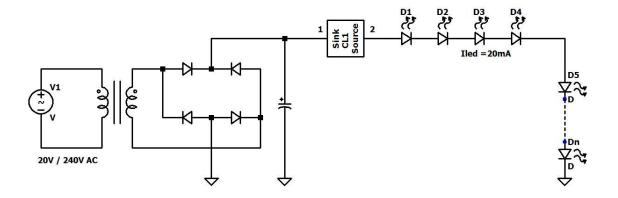




May 2021

Typical Application Circuits

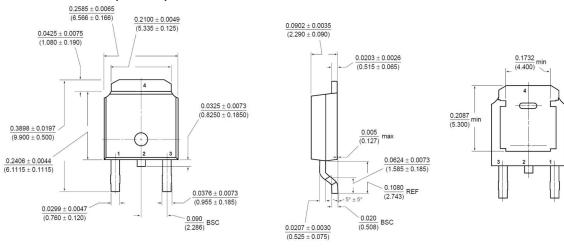




May 2021

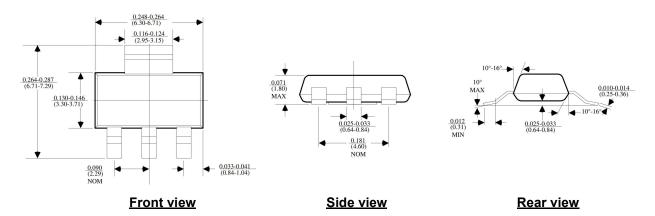
Package Dimensions

3-Lead TO-252 (DPAK)



Front view Side view Rear view

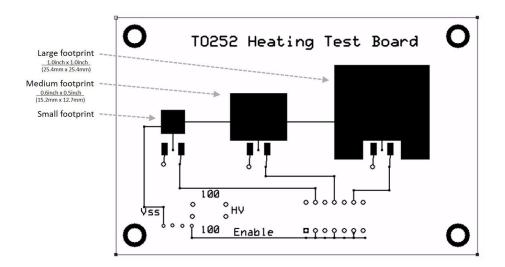
3-Lead SOT-223

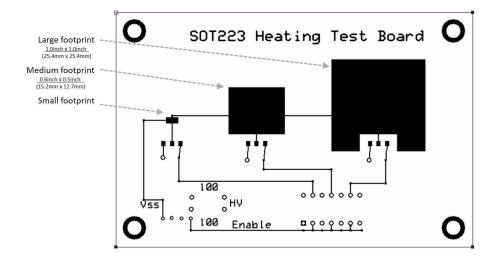


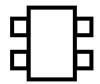
May 2021

Thermal properties test boards:

(Schematics not to scale)

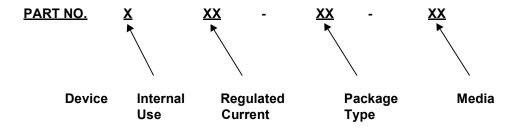






May 2021

Product Identification Codes



Device: CL1 = Temperature Compensated Unipolar Current Regulator

Internal use: A = Internal Use

ВС

Regulated Current: 5 = 5mA

10 = 10mA 15 = 15mA 20 = 20mA

Package: M = SOT-223

ST = TO-252 (DPAK)

Media Type: B = Bulk Samples

T = Tubes
TR = Tape & Reel